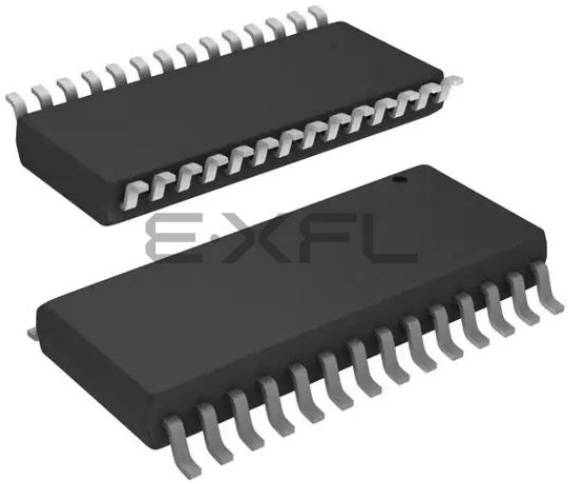

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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	25
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	224 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 24x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf15354t-i-so

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4.1.1 READING PROGRAM MEMORY AS DATA

There are three methods of accessing constants in program memory. The first method is to use tables of RETLW instructions. The second method is to set an FSR to point to the program memory. The third method is to use the NVMREG interface to access the program memory. For an example of NVREG interface use, reference Section 13.3, NVMREG Access.

4.1.1.1 RETLW Instruction

The RETLW instruction can be used to provide access to tables of constants. The recommended way to create such a table is shown in Example 4-1.

EXAMPLE 4-1: RETLW INSTRUCTION

```
constants
    BRW                 ;Add Index in W to
                        ;program counter to
                        ;select data
    RETLW DATA0         ;Index0 data
    RETLW DATA1         ;Index1 data
    RETLW DATA2
    RETLW DATA3


my_function
    ;… LOTS OF CODE…
    MOVLW       DATA_INDEX
    call constants
    ;… THE CONSTANT IS IN W
```

The BRW instruction makes this type of table very simple to implement.

4.1.1.2 Indirect Read with FSR

The program memory can be accessed as data by setting bit 7 of an FSRxH register and reading the matching INDFx register. The MOVIW instruction will place the lower eight bits of the addressed word in the W register. Writes to the program memory cannot be performed via the INDF registers. Instructions that read the program memory via the FSR require one extra instruction cycle to complete. Example 4-2 demonstrates reading the program memory via an FSR.

The High directive will set bit 7 if a label points to a location in the program memory.

EXAMPLE 4-2: ACCESSING PROGRAM MEMORY VIA FSR

```
constants
    RETLW DATA0         ;Index0 data
    RETLW DATA1         ;Index1 data
    RETLW DATA2
    RETLW DATA3
my_function
    ;… LOTS OF CODE…
    MOVLW   LOW constants
    MOVWF   FSR1L
    MOVLW   HIGH constants
    MOVWF   FSR1H
    MOVIW   0[FSR1]
;THE PROGRAM MEMORY IS IN W
```


TABLE 4-10: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 2											
CPU CORE REGISTERS; see Table 4-3 for specifics											
10Ch — 118h	—	Unimplemented								—	—
119h	RC1REG	EUSART Receive Data Register								0000 0000	0000 0000
11Ah	TX1REG	EUSART Transmit Data Register								0000 0000	0000 0000
11Bh	SP1BRGL	SP1BRG<7:0>								0000 0000	0000 0000
11Ch	SP1BRGH	SP1BRG<15:8>								0000 0000	0000 0000
11Dh	RC1STA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	0000 0000	0000 0000
11Eh	TX1STA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	0000 0010	0000 0010
11Fh	BAUD1CON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	01-0 0-00	01-0 0-00

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

TABLE 5-1: BOOT BLOCK SIZE BITS

$\overline{\text{BBEN}}$	BBSIZE<2:0>	Actual Boot Block Size User Program Memory Size (words)		Last Boot Block Memory Access
		PIC16(L)F15354	PIC16(L)F15355	
1	xxx	0	0	–
0	111	512	512	01FFh
0	110	1024	1024	03FFh
0	101	2048	2048	07FFh
0	100	–	4096	0FFFh

Note: The maximum boot block size is half the user program memory size. All selections higher than the maximum are set to half size. For example, all BBSIZE = 000 - 100 produce a boot block size of 4kW on a 8kW device.

REGISTER 5-5: CONFIGURATION WORD 5: CODE PROTECTION

U-1	U-1	U-1	U-1	U-1	U-1
—	—	—	—	—	—
bit 13					bit 8

U-1	U-1	U-1	U-1	U-1	U-1	U-1	R/P-1
—	—	—	—	—	—	—	$\overline{\text{CP}}$
bit 7							bit 0

Legend:			
R = Readable bit	P = Programmable bit	x = Bit is unknown	U = Unimplemented bit, read as ‘1’
‘0’ = Bit is cleared	‘1’ = Bit is set	W = Writable bit	n = Value when blank or after Bulk Erase

bit 13-1 **Unimplemented:** Read as ‘1’

bit 0 **$\overline{\text{CP}}$:** Program Flash Memory Code Protection bit
1 = Program Flash Memory code protection disabled
0 = Program Flash Memory code protection enabled

TABLE 9-3: SUMMARY OF REGISTERS ASSOCIATED WITH CLOCK SOURCES

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
OSCCON1	—	NOSC<2:0>			NDIV<3:0>				108
OSCCON2	—	COSC<2:0>			CDIV<3:0>				108
OSCCON3	CWSHOLD	SOSCPWR	—	ORDY	NOSCR	—	—	—	109
OSCFRQ	—	—	—	—	—	HFFRQ<2:0>			112
OSCSTAT	EXTOR	HFOR	MFOR	LFOR	SOR	ADOR	—	PLLR	110
OSCTUNE	—	—	HFTUN<5:0>						113
OSCEN	EXTOEN	HFOEN	MFOEN	LFOEN	SOSCEN	ADOEN	—	—	111

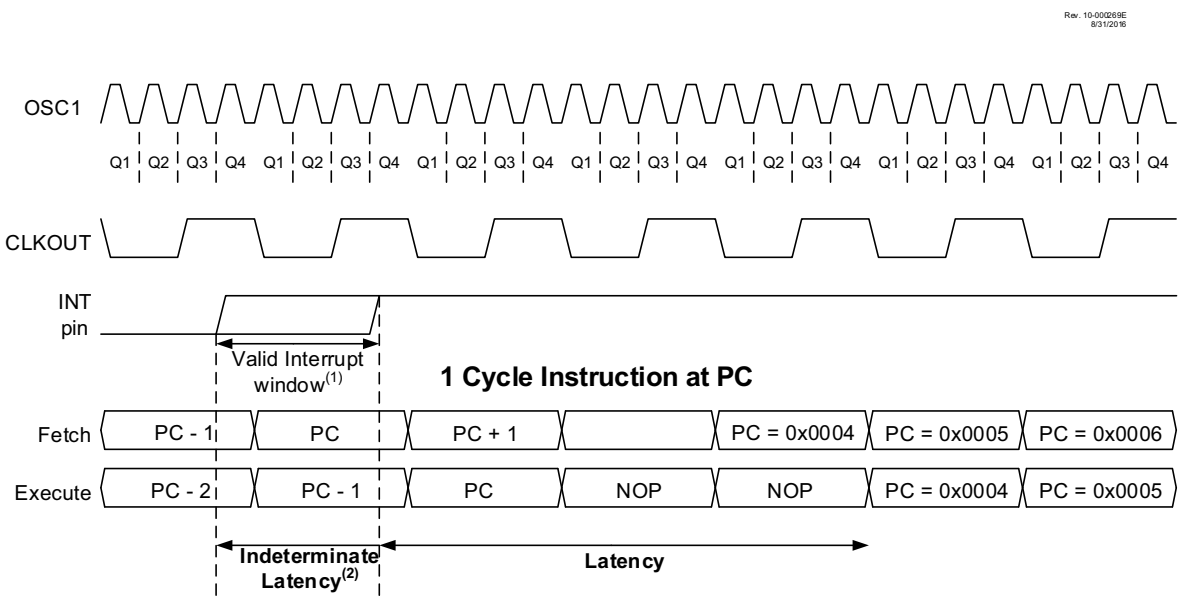
Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

TABLE 9-4: SUMMARY OF CONFIGURATION WORD WITH CLOCK SOURCES

Name	Bits	Bit -/7	Bit -/6	Bit 13/5	Bit 12/4	Bit 11/3	Bit 10/2	Bit 9/1	Bit 8/0	Register on Page
CONFIG1	13:8	—	—	FCMEN	—	CSWEN	—	—	$\overline{\text{CLKOUTEN}}$	75
	7:0	—	RSTOSC<2:0>			—	FEXTOSC<2:0>			

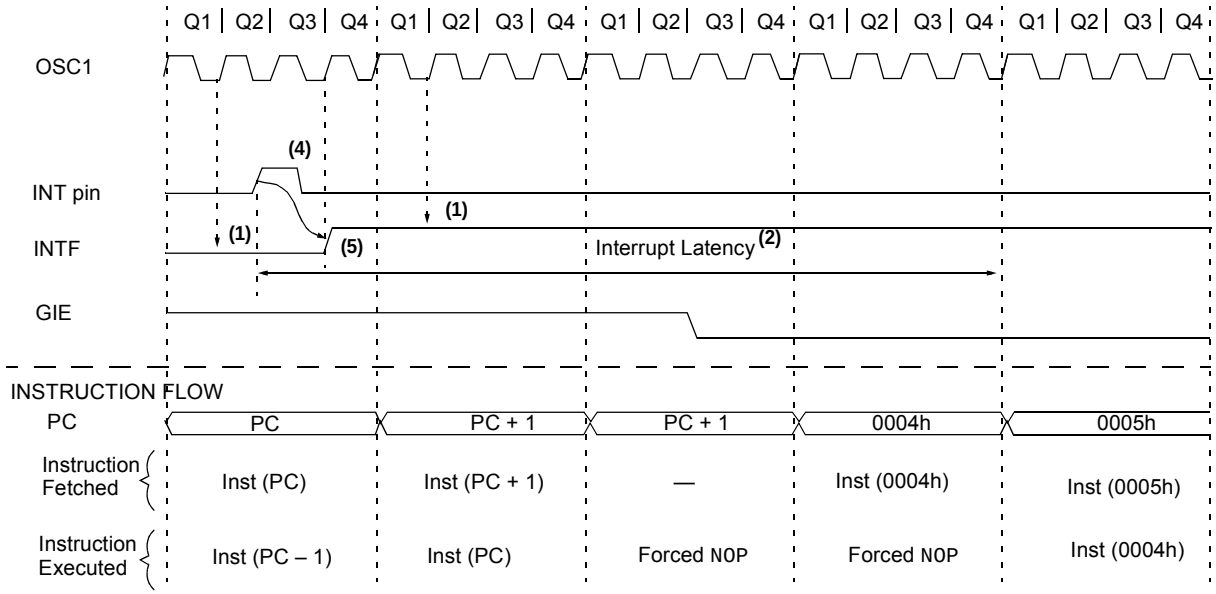
Legend: — = unimplemented location, read as '0'. Shaded cells are not used by clock sources.

FIGURE 10-2: INTERRUPT LATENCY



Note 1: An interrupt may occur at any time during the interrupt window.
2: Since an interrupt may occur any time during the interrupt window, the actual latency can vary.

FIGURE 10-3: INT PIN INTERRUPT TIMING



Note 1: INTF flag is sampled here (every Q1).

2: Asynchronous interrupt latency = 3-5 TCY. Synchronous latency = 3-4 TCY, where TCY = instruction cycle time. Latency is the same whether Inst (PC) is a single cycle or a 2-cycle instruction.

3: For minimum width of INT pulse, refer to AC specifications in **Section 37.0 "Electrical Specifications"**.

4: INTF is enabled to be set any time during the Q4-Q1 cycles.

REGISTER 10-7: PIE5: PERIPHERAL INTERRUPT ENABLE REGISTER 5

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
CLC4IE	CLC3IE	CLC2IE	CLC1IE	—	—	—	TMR1GIE
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS = Hardware set

bit 7 **CLC4IE:** CLC4 Interrupt Enable bit
1 = CLC4 interrupt enabled
0 = CLC4 interrupt disabled

bit 6 **CLC3IE:** CLC3 Interrupt Enable bit
1 = CLC3 interrupt enabled
0 = CLC3 interrupt disabled

bit 5 **CLC2IE:** CLC2 Interrupt Enable bit
1 = CLC2 interrupt enabled
0 = CLC2 interrupt disabled

bit 4 **CLC1IE:** CLC1 Interrupt Enable bit
1 = CLC1 interrupt enabled
0 = CLC1 interrupt disabled

bit 3-1 **Unimplemented:** Read as '0'

bit 0 **TMR1GIE:** Timer1 Gate Interrupt Enable bit
1 = Enables the Timer1 gate acquisition interrupt
0 = Disables the Timer1 gate acquisition interrupt

Note: Bit PEIE of the INTCON register must be set to enable any peripheral interrupt controlled by registers PIE1-PIE7.

REGISTER 10-12: PIR2: PERIPHERAL INTERRUPT REQUEST REGISTER 2

U-0	R/W/HS-0/0	U-0	U-0	U-0	U-0	R/W/HS-0/0	R/W/HS-0/0
—	ZCDIF	—	—	—	—	C2IF	C1IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS = Hardware set

bit 7 **Unimplemented**: Read as '0'

bit 6 **ZCDIF:** Zero-Cross Detect (ZCD1) Interrupt Flag bit
1 = An enabled rising and/or falling ZCD1 event has been detected (must be cleared in software)
0 = No ZCD1 event has occurred

bit 5-2 **Unimplemented**: Read as '0'

bit 1 **C2IF**: Comparator C2 Interrupt Flag bit
1 = Comparator 2 interrupt asserted (must be cleared in software)
0 = Comparator 2 interrupt not asserted

bit 0 **C1IF:** Comparator C1 Interrupt Flag bit
1 = Comparator 1 interrupt asserted (must be cleared in software)
0 = Comparator 1 interrupt not asserted

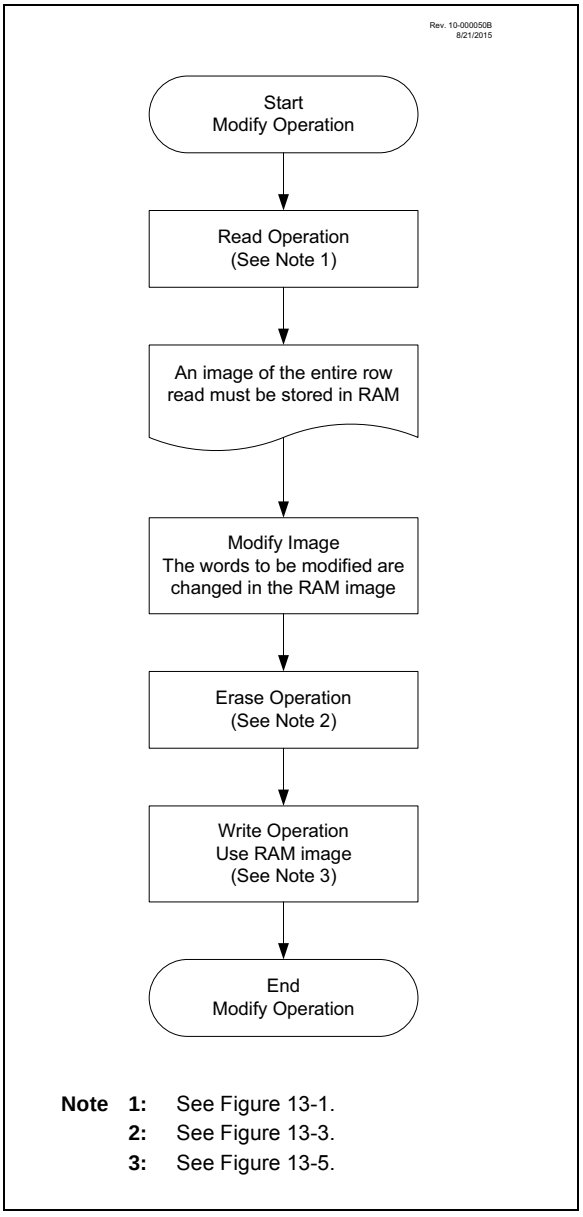
Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

13.3.5 MODIFYING FLASH PROGRAM MEMORY

When modifying existing data in a program memory row, and data within that row must be preserved, it must first be read and saved in a RAM image. Program memory is modified using the following steps:

1. Load the starting address of the row to be modified.
2. Read the existing data from the row into a RAM image.
3. Modify the RAM image to contain the new data to be written into program memory.
4. Load the starting address of the row to be rewritten.
5. Erase the program memory row.
6. Load the write latches with data from the RAM image.
7. Initiate a programming operation.

FIGURE 13-6: FLASH PROGRAM MEMORY MODIFY FLOWCHART



Note 1: See Figure 13-1.
2: See Figure 13-3.
3: See Figure 13-5.

17.5 Register Definitions: Interrupt-on-Change Control

REGISTER 17-1: IOCAP: INTERRUPT-ON-CHANGE PORTA POSITIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCAP7	IOCAP6	IOCAP5	IOCAP4	IOCAP3	IOCAP2	IOCAP1	IOCAP0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **IOCAP<7:0>:** Interrupt-on-Change PORTA Positive Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a positive-going edge. IOCAFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin.

REGISTER 17-2: IOCAN: INTERRUPT-ON-CHANGE PORTA NEGATIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCAN7	IOCAN6	IOCAN5	IOCAN4	IOCAN3	IOCAN2	IOCAN1	IOCAN0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **IOCAN<7:0>:** Interrupt-on-Change PORTA Negative Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a negative-going edge. IOCAFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin.

REGISTER 17-3: IOCAF: INTERRUPT-ON-CHANGE PORTA FLAG REGISTER

R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0	R/W/HS-0/0
IOCAF7	IOCAF6	IOCAF5	IOCAF4	IOCAF3	IOCAF2	IOCAF1	IOCAF0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HS - Bit is set in hardware

bit 7-0 **IOCAF<7:0>:** Interrupt-on-Change PORTA Flag bits
1 = An enabled change was detected on the associated pin.
Set when IOCAPx = 1 and a rising edge was detected on RAx, or when IOCANx = 1 and a falling edge was detected on RAx.
0 = No change was detected, or the user cleared the detected change.

19.0 TEMPERATURE INDICATOR MODULE

This family of devices is equipped with a temperature circuit designed to measure the operating temperature of the silicon die. The main purpose of the temperature sensor module is to provide a temperature-dependent voltage that can be measured by the Analog-to-Digital Converter.

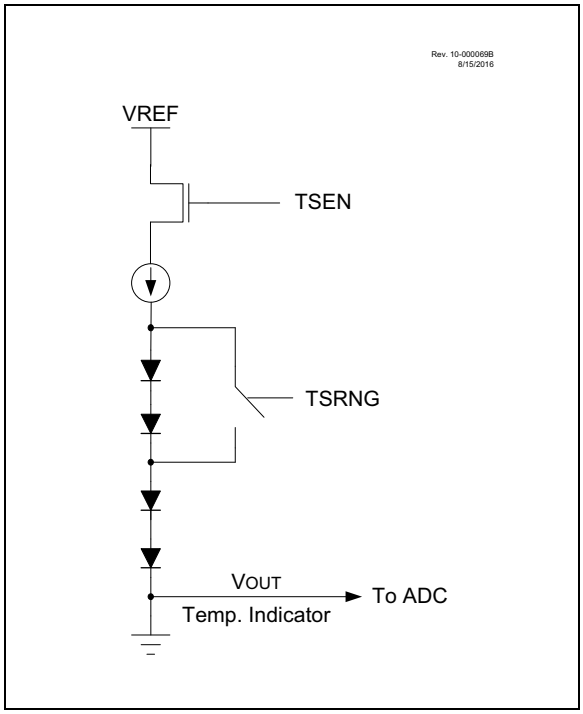
The circuit's range of operating temperature falls between -40°C and +125°C. The circuit may be used as a temperature threshold detector or a more accurate temperature indicator, depending on the level of calibration performed. A one-point calibration allows the circuit to indicate a temperature closely surrounding that point. A two-point calibration allows the circuit to sense the entire range of temperature more accurately.

19.1 Module Operation

The temperature-sensing circuit provides a voltage to the device ADC. The analog voltage output, VTSENSE, varies inversely to the device temperature.

Figure 19-1 shows a simplified block diagram of the temperature circuit.

FIGURE 19-1: TEMPERATURE SENSOR BLOCK DIAGRAM



The output of the circuit is measured using the internal Analog-to-Digital Converter. A channel is reserved for the temperature circuit output. Refer to **Section 20.0 "Analog-to-Digital Converter (ADC) Module"** for detailed information.

The ON/OFF bit for the module is located in the FVRCON register. See **Section 18.0 "Fixed Voltage Reference (FVR)"** for more information. The circuit is enabled by setting the TSEN bit of the FVRCON register. When disabled, the circuit draws no current.

The circuit operates in either High or Low range. The High range, selected by setting the TSRNG bit of the FVRCON register, provides a wider output voltage. This provides more resolution over the temperature range. High range requires a higher-bias voltage to operate and thus, a higher VDD is needed. The Low range is selected by clearing the TSRNG bit of the FVRCON register. The Low range generates a lower sensor voltage and thus, a lower VDD voltage is needed to operate the circuit.

19.2 Estimation of Temperature

This section describes how the sensor voltage can be used to estimate the temperature of the module. To use the sensor, the output voltage, VTSENSE, is measured and the corresponding temperature is determined. Equation 19-1 provides an estimate for the die temperature based on the VTSENSE value.

EQUATION 19-1: SENSOR TEMPERATURE

$$T_{SENSE} = V_{TSENSE} \times (-Mt) + T_{OFFSET}$$

Where:
Mt = 1/Mv, where Mv = sensor voltage sensitivity (V/°C).
TOFFSET is the temperature difference between the theoretical temperature and the actual temperature.

REGISTER 20-2: ADCON1: ADC CONTROL REGISTER 1

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	R/W-0/0	R/W-0/0
ADFM	ADCS<2:0>			—	—	ADPREF<1:0>	
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7 **ADFM:** ADC Result Format Select bit
- 1 = Right justified. Six Most Significant bits of ADRESH are set to '0' when the conversion result is loaded.
- 0 = Left justified. Six Least Significant bits of ADRESL are set to '0' when the conversion result is loaded.

bit 6-4 **ADCS<2:0>:** ADC Conversion Clock Select bits
- 111 = ADCRC (dedicated RC oscillator)
- 110 = FOSC/64
- 101 = FOSC/16
- 100 = FOSC/4
- 011 = ADCRC (dedicated RC oscillator)
- 010 = FOSC/32
- 001 = FOSC/8
- 000 = FOSC/2

bit 3-2 **Unimplemented:** Read as '0'

bit 1-0 **ADPREF<1:0>:** ADC Positive Voltage Reference Configuration bits
- 11 = VREF+ is connected to internal Fixed Voltage Reference (FVR) module(1)
- 10 = VREF+ is connected to external VREF+ pin(1)
- 01 = Reserved
- 00 = VREF+ is connected to VDD

Note 1: When selecting the VREF+ pin as the source of the positive reference, be aware that a minimum voltage specification exists. See Table 37-14 for details.

23.2 Comparator Control

Each comparator has two control registers: CMxCON0 and CMxCON1.

The CMxCON0 register (see Register 23-1) contains Control and Status bits for the following:

- Enable
- Output
- Output polarity
- Hysteresis enable
- Timer1 output synchronization

The CMxCON1 register (see Register 23-2) contains Control bits for the following:

- Interrupt on positive/negative edge enables
- The CMxNSEL and CMxPSEL (Register 23-3 and Register 23-4) contain control bits for the following:
  - Positive input channel selection
  - Negative input channel selection

23.2.1 COMPARATOR ENABLE

Setting the CxON bit of the CMxCON0 register enables the comparator for operation. Clearing the CxON bit disables the comparator resulting in minimum current consumption.

23.2.2 COMPARATOR OUTPUT

The output of the comparator can be monitored by reading either the CxOUT bit of the CMxCON0 register or the MCxOUT bit of the CMOUT register.

The comparator output can also be routed to an external pin through the RxyPPS register (Register 15-2). The corresponding TRIS bit must be clear to enable the pin as an output.

Note 1:	The internal output of the comparator is latched with each instruction cycle. Unless otherwise specified, external outputs are not latched.

23.2.3 COMPARATOR OUTPUT POLARITY

Inverting the output of the comparator is functionally equivalent to swapping the comparator inputs. The polarity of the comparator output can be inverted by setting the CxPOL bit of the CMxCON0 register. Clearing the CxPOL bit results in a non-inverted output.

Table 23-2 shows the output state versus input conditions, including polarity control.

TABLE 23-2: COMPARATOR OUTPUT STATE VS. INPUT CONDITIONS

Input Condition	CxPOL	CxOUT
CxVN > CxVP	0	0
CxVN < CxVP	0	1
CxVN > CxVP	1	1
CxVN < CxVP	1	0

24.7 Operation During Sleep

The ZCD current sources and interrupts are unaffected by Sleep.

24.8 Effects of a Reset

The ZCD circuit can be configured to default to the active or inactive state on Power-on-Reset (POR). When the ZCDDIS Configuration bit is cleared, the ZCD circuit will be active at POR. When the $\overline{ZCD}$ Configuration bit is set, the EN bit of the ZCDxCON register must be set to enable the ZCD module.

25.2 Clock Source Selection

The T0CS<2:0> bits of the T0CON1 register are used to select the clock source for Timer0. Register 25-2 displays the clock source selections.

25.2.1 INTERNAL CLOCK SOURCE

When the internal clock source is selected, Timer0 operates as a timer and will increment on multiples of the clock source, as determined by the Timer0 prescaler.

25.2.2 EXTERNAL CLOCK SOURCE

When an external clock source is selected, Timer0 can operate as either a timer or a counter. Timer0 will increment on multiples of the rising edge of the external clock source, as determined by the Timer0 prescaler.

25.3 Programmable Prescaler

A software programmable prescaler is available for exclusive use with Timer0. There are 16 prescaler options for Timer0 ranging in powers of two from 1:1 to 1:32768. The prescaler values are selected using the T0CKPS<3:0> bits of the T0CON1 register.

The prescaler is not directly readable or writable. Clearing the prescaler register can be done by writing to the TMR0L register or the T0CON1 register.

25.4 Programmable Postscaler

A software programmable postscaler (output divider) is available for exclusive use with Timer0. There are 16 postscaler options for Timer0 ranging from 1:1 to 1:16. The postscaler values are selected using the T0OUTPS<3:0> bits of the T0CON0 register.

The postscaler is not directly readable or writable. Clearing the postscaler register can be done by writing to the TMR0L register or the T0CON0 register.

25.5 Operation during Sleep

When operating synchronously, Timer0 will halt. When operating asynchronously, Timer0 will continue to increment and wake the device from Sleep (if Timer0 interrupts are enabled) provided that the input clock source is active.

25.6 Timer0 Interrupts

The Timer0 interrupt flag bit (TMR0IF) is set when either of the following conditions occur:

- 8-bit TMR0L matches the TMR0H value
- 16-bit TMR0 rolls over from ‘FFFFh’

When the postscaler bits (T0OUTPS<3:0>) are set to 1:1 operation (no division), the T0IF flag bit will be set with every TMR0 match or rollover. In general, the TMR0IF flag bit will be set every T0OUTPS +1 matches or rollovers.

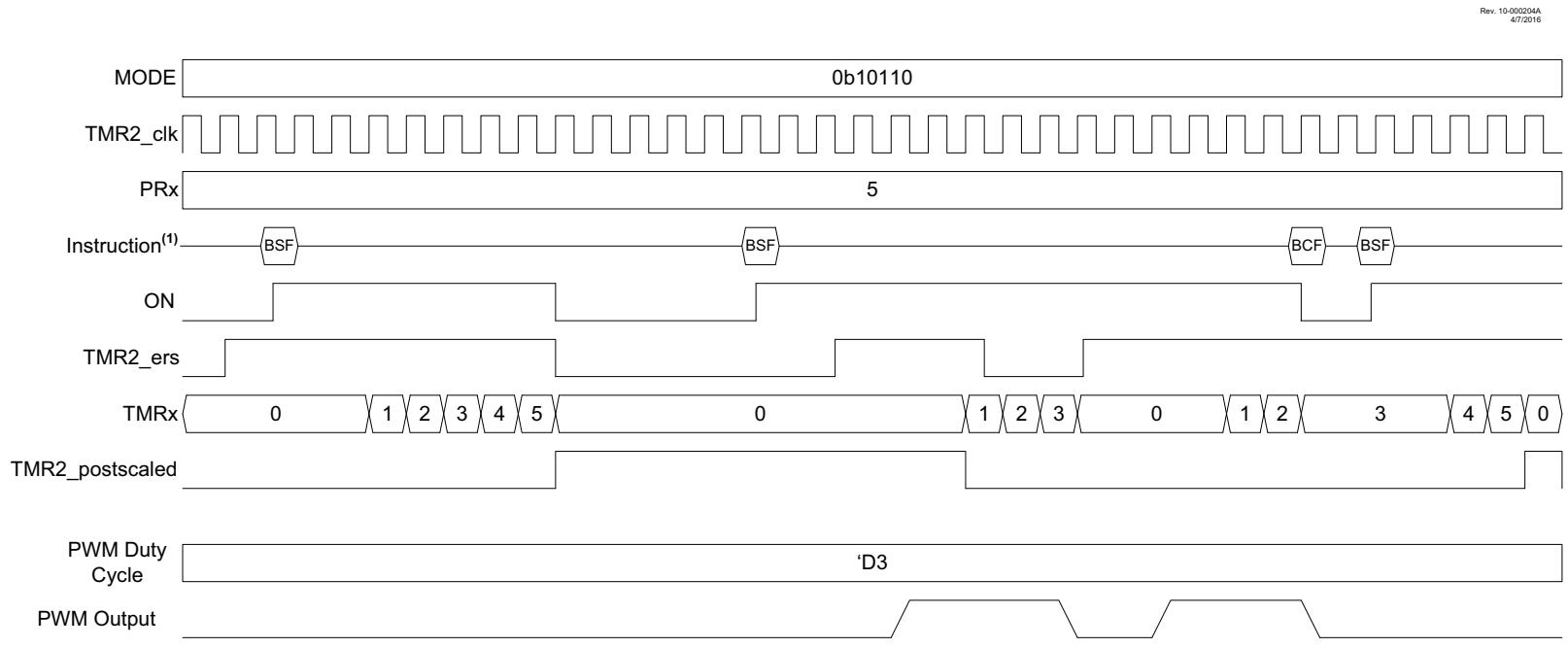
If Timer0 interrupts are enabled (TMR0IE bit of the PIE0 register = 1), the CPU will be interrupted and the device may wake from sleep (see **Section 25.2 “Clock Source Selection”** for more details).

25.7 Timer0 Output

The Timer0 output can be routed to any I/O pin via the RxyPPS output selection register (see **Section 15.0 “Peripheral Pin Select (PPS) Module”** for additional information). The Timer0 output can also be used by other peripherals, such as the Auto-conversion Trigger of the Analog-to-Digital Converter. Finally, the Timer0 output can be monitored through software via the Timer0 output bit (T0OUT) of the T0CON0 register (Register 25-1).

TMR0_out will be one postscaled clock period when a match occurs between TMR0L and TMR0H in 8-bit mode, or when TMR0 rolls over in 16-bit mode. The Timer0 output is a 50% duty cycle that toggles on each TMR0_out rising clock edge.

FIGURE 27-13: LEVEL-TRIGGERED HARDWARE LIMIT ONE-SHOT MODE TIMING DIAGRAM (MODE = 10110)



Note 1: BSF and BCF represent Bit-Set File and Bit-Clear File instructions executed by the CPU to set or clear the ON bit of TxCON. CPU execution is asynchronous to the timer clock input.

32.8 Register Definitions: MSSPx Control

REGISTER 32-1: SSPxSTAT: SSPx STATUS REGISTER

R/W-0/0	R/W-0/0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0	R/HS/HC-0
SMP	CKE(1)	D/$\overline{A}$	P(2)	S(2)	R/$\overline{W}$	UA	BF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS/HC = Hardware set/clear

bit 7 **SMP:** SPI Data Input Sample bit
SPI Master mode:
1 = Input data sampled at end of data output time
0 = Input data sampled at middle of data output time
SPI Slave mode:
SMP must be cleared when SPI is used in Slave mode
In I^2C Master or Slave mode:
1 = Slew rate control disabled for Standard Speed mode (100 kHz and 1 MHz)
0 = Slew rate control enabled for High-Speed mode (400 kHz)

bit 6 **CKE:** SPI Clock Edge Select bit (SPI mode only)(1)
In SPI Master or Slave mode:
1 = Transmit occurs on transition from active to Idle clock state
0 = Transmit occurs on transition from Idle to active clock state
In I^2C mode only:
1 = Enable input logic so that thresholds are compliant with SMBus specification
0 = Disable SMBus specific inputs

bit 5 **D/$\overline{A}$:** Data/$\overline{Address}$ bit (I^2C mode only)
1 = Indicates that the last byte received or transmitted was data
0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** Stop bit(2)
(I^2C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.)
1 = Indicates that a Stop bit has been detected last (this bit is '0' on Reset)
0 = Stop bit was not detected last

bit 3 **S:** Start bit (2)
(I^2C mode only. This bit is cleared when the MSSP module is disabled, SSPEN is cleared.)
1 = Indicates that a Start bit has been detected last (this bit is '0' on Reset)
0 = Start bit was not detected last

bit 2 **R/$\overline{W}$:** Read/$\overline{Write}$ bit information (I^2C mode only)
This bit holds the R/$\overline{W}$ bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit, or not $\overline{ACK}$ bit.
In I^2C Slave mode:
1 = Read
0 = Write
In I^2C Master mode:
1 = Transmit is in progress
0 = Transmit is not in progress
OR-ing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSP is in IDLE mode.

bit 1 **UA:** Update Address bit (10-bit I^2C mode only)
1 = Indicates that the user needs to update the address in the SSPxADD register
0 = Address does not need to be updated

bit 0 **BF:** Buffer Full Status bit
Receive (SPI and I^2C modes):
1 = Receive complete, SSPxBUF is full
0 = Receive not complete, SSPxBUF is empty
Transmit (I^2C mode only):
1 = Data transmit in progress (does not include the $\overline{ACK}$ and Stop bits), SSPxBUF is full
0 = Data transmit complete (does not include the $\overline{ACK}$ and Stop bits), SSPxBUF is empty

Note 1: Polarity of clock state is set by the CKP bit of the SSPxCON register.
2: This bit is cleared on Reset and when SSPEN is cleared.

33.1.2.3 Receive Interrupts

The RXxIF interrupt flag bit of the PIR3 register is set whenever the EUSART receiver is enabled and there is an unread character in the receive FIFO. The RXxIF interrupt flag bit is read-only, it cannot be set or cleared by software.

RXxIF interrupts are enabled by setting all of the following bits:

- RXxIE, Interrupt Enable bit of the PIE3 register
- PEIE, Peripheral Interrupt Enable bit of the INTCON register
- GIE, Global Interrupt Enable bit of the INTCON register

The RXxIF interrupt flag bit will be set when there is an unread character in the FIFO, regardless of the state of interrupt enable bits.

33.1.2.4 Receive Framing Error

Each character in the receive FIFO buffer has a corresponding framing error Status bit. A framing error indicates that a Stop bit was not seen at the expected time. The framing error status is accessed via the FERR bit of the RCxSTA register. The FERR bit represents the status of the top unread character in the receive FIFO. Therefore, the FERR bit must be read before reading the RCxREG.

The FERR bit is read-only and only applies to the top unread character in the receive FIFO. A framing error (FERR = 1) does not preclude reception of additional characters. It is not necessary to clear the FERR bit. Reading the next character from the FIFO buffer will advance the FIFO to the next character and the next corresponding framing error.

The FERR bit can be forced clear by clearing the SPEN bit of the RCxSTA register which resets the EUSART. Clearing the CREN bit of the RCxSTA register does not affect the FERR bit. A framing error by itself does not generate an interrupt.

Note:	If all receive characters in the receive FIFO have framing errors, repeated reads of the RCxREG will not clear the FERR bit.

33.1.2.5 Receive Overrun Error

The receive FIFO buffer can hold two characters. An overrun error will be generated if a third character, in its entirety, is received before the FIFO is accessed. When this happens the OERR bit of the RCxSTA register is set. The characters already in the FIFO buffer can be read but no additional characters will be received until the error is cleared. The error must be cleared by either clearing the CREN bit of the RCxSTA register or by resetting the EUSART by clearing the SPEN bit of the RCxSTA register.

33.1.2.6 Receiving 9-Bit Characters

The EUSART supports 9-bit character reception. When the RX9 bit of the RCxSTA register is set the EUSART will shift nine bits into the RSR for each character received. The RX9D bit of the RCxSTA register is the ninth and Most Significant data bit of the top unread character in the receive FIFO. When reading 9-bit data from the receive FIFO buffer, the RX9D data bit must be read before reading the eight Least Significant bits from the RCxREG.

33.1.2.7 Address Detection

A special Address Detection mode is available for use when multiple receivers share the same transmission line, such as in RS-485 systems. Address detection is enabled by setting the ADDEN bit of the RCxSTA register.

Address detection requires 9-bit character reception. When address detection is enabled, only characters with the ninth data bit set will be transferred to the receive FIFO buffer, thereby setting the RXxIF interrupt bit. All other characters will be ignored.

Upon receiving an address character, user software determines if the address matches its own. Upon address match, user software must disable address detection by clearing the ADDEN bit before the next Stop bit occurs. When user software detects the end of the message, determined by the message protocol used, software places the receiver back into the Address Detection mode by setting the ADDEN bit.

TABLE 37-6: THERMAL CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated)					
Param. No.	**Sym.**	**Characteristic**	**Typ.**	**Units**	**Conditions**
TH01	θ_{JA}	Thermal Resistance Junction to Ambient	60	°C/W	28-pin SPDIP package
			80	°C/W	28-pin SOIC package
			90	°C/W	28-pin SSOP package
			48	°C/W	28-pin UQFN 4x4mm package
TH02	θ_{JC}	Thermal Resistance Junction to Case	31.4	°C/W	28-pin SPDIP package
			24	°C/W	28-pin SOIC package
			24	°C/W	28-pin SSOP package
			12	°C/W	28-pin UQFN 4x4mm package
TH03	T_{JMAX}	Maximum Junction Temperature	150	°C	
TH04	PD	Power Dissipation	—	W	$PD = P_{INTERNAL} + P_{I/O}$
TH05	$P_{INTERNAL}$	Internal Power Dissipation	—	W	$P_{INTERNAL} = I_{DD} \times V_{DD}$ (1)
TH06	$P_{I/O}$	I/O Power Dissipation	—	W	$P_{I/O} = \Sigma (I_{OL} * V_{OL}) + \Sigma (I_{OH} * (V_{DD} - V_{OH}))$
TH07	P_{DER}	Derated Power	—	W	$P_{DER} = PD_{MAX} (T_J - T_A)/\theta_{JA}$ (2)

Note 1: I_{DD} is current to run the chip alone without driving any load on the output pins.

2: T_A = Ambient Temperature, T_J = Junction Temperature

TABLE 37-23: SPI MODE REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)							
Param. No.	**Symbol**	**Characteristic**	**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
SP70*	TssL2scH, TssL2scL	$\overline{SS}\downarrow$ to SCK$\downarrow$ or SCK$\uparrow$ input	2.25*Tcy	—	—	ns	
SP71*	TscH	SCK input high time (Slave mode)	Tcy + 20	—	—	ns	
SP72*	TscL	SCK input low time (Slave mode)	Tcy + 20	—	—	ns	
SP73*	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge	100	—	—	ns	
SP74*	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge	100	—	—	ns	
SP75*	TdoR	SDO data output rise time	—	10	25	ns	3.0V ≤ VDD ≤ 5.5V
			—	25	50	ns	1.8V ≤ VDD ≤ 5.5V
SP76*	TdoF	SDO data output fall time	—	10	25	ns	
SP77*	TssH2doZ	$\overline{SS}\uparrow$ to SDO output high-impedance	10	—	50	ns	
SP78*	TscR	SCK output rise time (Master mode)	—	10	25	ns	3.0V ≤ VDD ≤ 5.5V
			—	25	50	ns	1.8V ≤ VDD ≤ 5.5V
SP79*	TscF	SCK output fall time (Master mode)	—	10	25	ns	
SP80*	TscH2doV, TscL2doV	SDO data output valid after SCK edge	—	—	50	ns	3.0V ≤ VDD ≤ 5.5V
			—	—	145	ns	1.8V ≤ VDD ≤ 5.5V
SP81*	TdoV2scH, TdoV2scL	SDO data output setup to SCK edge	1 Tcy	—	—	ns	
SP82*	TssL2doV	SDO data output valid after $\overline{SS}\downarrow$ edge	—	—	50	ns	
SP83*	TscH2ssH, TscL2ssH	$\overline{SS}\uparrow$ after SCK edge	1.5 Tcy + 40	—	—	ns	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

